

06-30-1999

ACTION FORM COVER SHEET
PATENTS ONLY

mkb 6-15-99

To the

101080117

U.S. Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

(a) Myung Kee Chung

(b) Jin Soon Lee

(c) Ho Tae Jin and In Pyo Hong

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.

Internal Address: _____

Street Address: 416, Maetan-dong, Paldal-ku, Suwon-cityCity Kyungki-do State Republic of Korea ZIP _____

Additional name(s) & address(es) attached?

☐ Yes☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Execution Date: June 5, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

June 5, 1999

A. Patent Application No.(s) - Not assigned

Title: **Method For Manufacturing Semiconductor Package
Of Center Pad Type Device**

B. Patent No.(s)

N/A

09 333772

Additional numbers attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

06/22/1999 TRADE 00000009 192386 09333772

Name: David T. MillersInternal Address: SKJERVEN, MORRILL, MacPHERSON,FRANKLIN & FRIEL LLPStreet Address: 25 METRO DRIVE, SUITE 700City SAN JOSE State CA ZIP 951106. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41): \$40.00☒ Authorized to be charged to Deposit Account 19-2386☒ Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

DO NOT USE THIS SPACE

8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David T. Millers

37,396

Name of Person Signing

David Millers

Signature

6-15-99

Date

Total number of pages comprising cover sheet: 1

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Myung Kee Chung

of

No. 103-1501, Haenuri Seonkyung Apt.
Ssangyong-dong, Cheonan-city
Chungcheongnam-do, Republic of Korea

Jin Soon Lee

of

No. 1503, Ilseong 4th Apt.
Ssangyong-dong, Cheonan-city
Chungcheongnam-do, Republic of Korea

Ho Tae Jin

of

No. 3-1404, Ssangyong Moran Apt.
Ssangyong-dong, Cheonan-city
Chungcheongnam-do, Republic of Korea

In Pyo Hong

of

No. 2-605, Samsung 1st Apt.
Maetan-dong, Paldal-ku, Suwon-city
Kyungki-do, Republic of Korea

hereby sell, assign and transfer to **Samsung Electronics Co., Ltd.**, a Korean corporation, having a place of business at **416, Maetan-dong, Paldal-ku, Suwon-city**, its successors and assigns, the entire right, title and interest throughout the world in our invention in

Method For Manufacturing Semiconductor Package Of Center Pad Type Device

for which we have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 5th day of June, 1999.

Myung Kee Chung
Myung Kee Chung

Executed this 5th day of June, 1999.

Jin Soon Lee
Jin Soon Lee

Executed this 5th day of June, 1999.

Ho Tae Jin
Ho Tae Jin

Executed this 5th day of June, 1999.

In Pyo Hong
In Pyo Hong